5-146281-6 V ACTIVE

AMPMODU

TE Internal #: 5-146281-6

PCB Mount Header, Vertical, Board-to-Board, 6 Position, 2.54 mm [. 1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal,

Black

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Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 6
Number of Rows: 1

Features

Product Type Features

| PCB Connector Assembly Type | PCB Mount Header |
|-----------------------------------|-----------------------|
| Connector System | Board-to-Board |
| Header Type | Breakaway |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |
| Configuration Factures | |

Configuration Features

| PCB Mount Orientation | Vertical |
|------------------------------|----------|
| Number of Positions | 6 |
| Number of Rows | 1 |
| Board-to-Board Configuration | Parallel |

Body Features

Contact Features

| PCB Contact Termination Area Plating Material Thickness | 2.54 – 5.08 μm[100 – 200 μin] | |
|---------------------------------------------------------|-------------------------------|--|



| Contact Underplating Material Thickness | 1.27 μm[50 μin] |
|------------------------------------------------------|----------------------------|
| PCB Contact Termination Area Plating Material Finish | Matte |
| Contact Shape & Form | Square |
| Contact Underplating Material | Nickel |
| PCB Contact Termination Area Plating Material | Tin |
| Contact Base Material | Copper Alloy |
| Contact Mating Area Plating Material | Gold |
| Contact Mating Area Plating Material Thickness | .76 μm[30 μin] |
| Contact Type | Pin |
| Contact Current Rating (Max) | 3 A |
| Termination Features | |
| Termination Method to Printed Circuit Board | Through Hole - Solder |
| Mechanical Attachment | |
| Mating Alignment | Without |
| PCB Mount Retention | Without |
| PCB Mount Alignment | Without |
| Connector Mounting Type | Board Mount |
| Housing Features | |
| Centerline (Pitch) | 2.54 mm[.1 in] |
| Housing Material | LCP |
| Dimensions | |
| PCB Thickness (Recommended) | 1.6 mm[.063 in] |
| Usage Conditions | |
| Operating Temperature Range | -55 – 125 °C[-67 – 257 °F] |
| Operation/Application | |
| Circuit Application | Signal |
| Industry Standards | |
| UL Flammability Rating | UL 94V-0 |
| Packaging Features | |
| Packaging Type | Carton |
| | |



Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|-----------------------------------------------|---------------------------------------------------------------------------------------------------------------------------|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC |
| Halogen Content | Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free |
| Solder Process Capability | Pin-in-Paste capable to 260°C |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



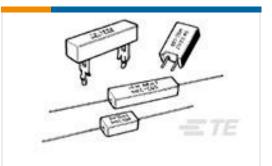
Customers Also Bought

PCB Mount Header, Vertical, Board-to-Board, 6 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, Black





TE Part #5102153-7 A/L UNIV HDR 30P VERT



TE Part #1623788-9 SQM5 1R0 5% (WIRE)



TE Part #2-164045-1 48P.IEC-F MALE CONN





TE Part #5767096-8 MICT,REC,038,ASY,.025,TAPE,CAP



TE Part #1-826656-3 13P AMPMODU II STIFT LEI



TE Part #5650893-5 ASSY,RECEPT,EUROCARD,TYPE R/2,L-FREE,48,





TE Part #4-1546108-4
EUROSTYLE TB,PLUG,GREY,STKG 8P

TE Part #1-2309976-3
ZSFP+ 1X4 CAGE ASSEMBLY,
PRESSFIT, HS&LP

Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5-146281-6_D.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_5-146281-6_D.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5-146281-6_D.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

Datasheets & Catalog Pages

AMPMODU Interconnetion System

AMPMODU Interconnetion System

English

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Product Specifications

Application Specification

English

Product Environmental Compliance

Product Compliance

English

Product Compliance

English